

Chest X-ray Taking Procedures Training for X-ray Technicians/ Radiographer

"Digital Radiography"

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Digital Radiography

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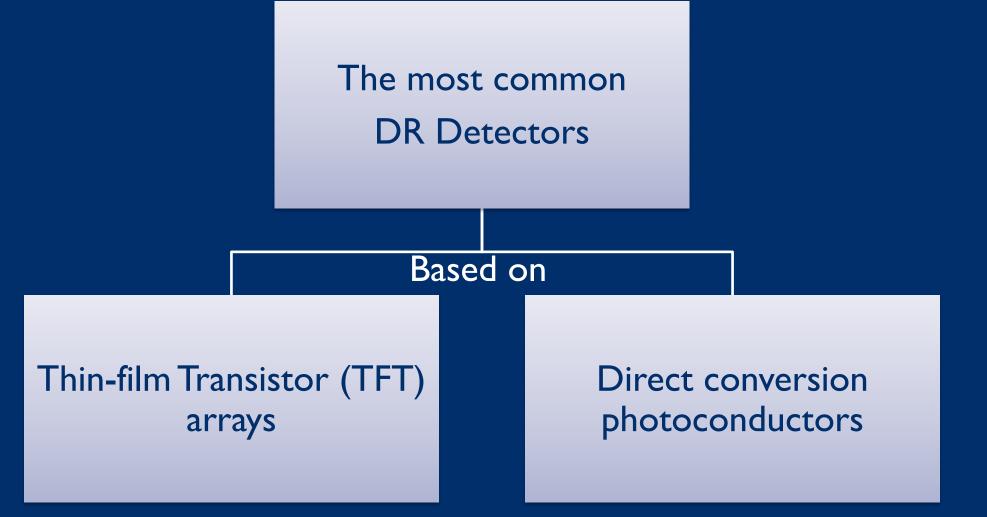
Digital Radiography (DR)

The DR image is produced directly from the image detector and is displayed on the screen.



Photo reference: Author, Andreas -horn- Hornig Access for free at (https://commons.wikimedia.org/wiki/File:CeBIT_2006_Chi_Mei_Optoelectronics_56LCD_QuadHDTV_digital_radiography_Digitalroentgen_by_HDTVTotalD OTcom.jpg)

Digital Radiography (DR)



Thin film transistors (TFT)

• Used in both direct and indirect conversion

Structure:

- Deposited in multiple layers on glass substrate
- Higher layer has charged collectors X ray elements
- Light sensitive elements are deposited on the top layer
- Lowest layer has readout electronics
- Encased in a protective layer for insulation connected to computers through wire for image reconstruction

Thin film transistors (TFT) – Cont.

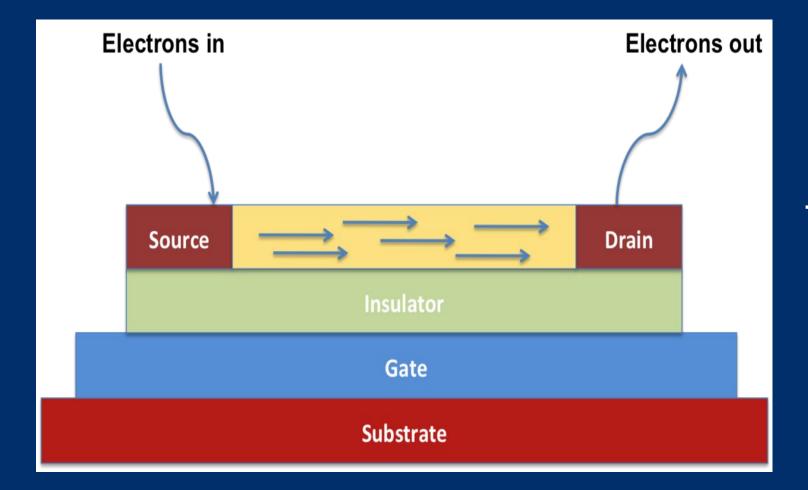




Photo reference: Author, Myxiao Access for free at (https://commons.wikimedia.org/wiki/File:Tft.png)

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Direct conversion photoconductors

- Used amorphous selenium and lead iodide
- Most commonly selenium is used
- Selenium drum or flat panel detector can be used

Types of Digital Radiography

Indirect conversion type

- X ray to visible light by scintillator
- Visible light to electrical charges by photo detectors

Direct conversion type

• Photoconductors like amorphous selenium directly

Types of Digital Radiography – Cont.

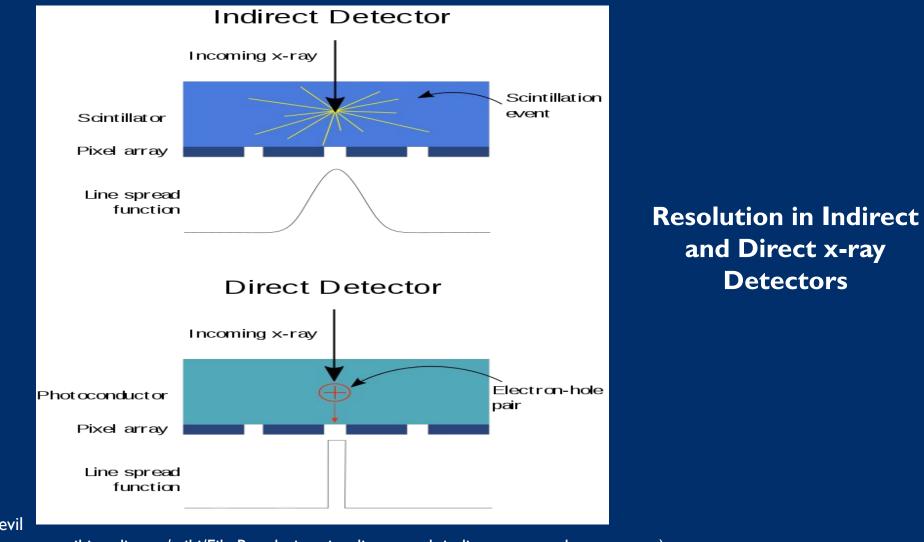


Photo reference: Author, Beevil

Access for free at (https://commons.wikimedia.org/wiki/File:Resolution_in_direct_and_indirect_x-ray_detectors.svg)

I. Image formation steps by indirect conversion type

Consists of scintillator

(thallium doped cesium iodide to convert x-rays into light)

TFT arrays (CsI:TI) and charge coupled device CCD system

*CCD system – light sensitive sensor

CsI:TI absorbs x-ray photons and releases light photons

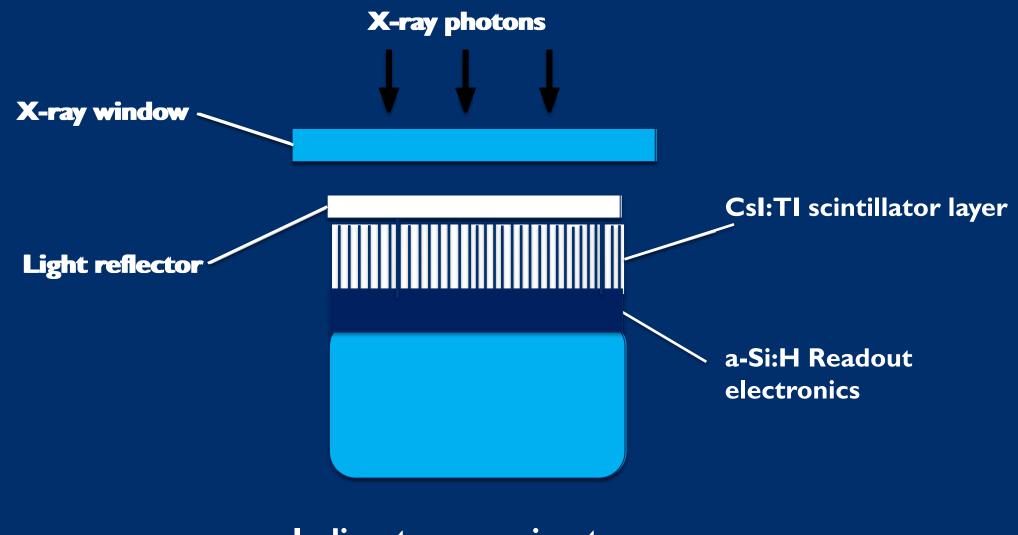
Light photons are then absorbed in the photodiodes

I. Image formation steps by indirect conversion type – Cont.

Electrical charges stored in the charge storage capacitor at each pixel location

The latent image is read out by TFT array

The resulting voltage signal is then digitised and transferred to the system computer where the DR image is built up



Indirect conversion type

Indirect conversion type

Active Matrix:

- Formed by a layer of a-Si:H and forms the readout electronics
- Consists of a high resolution array of electronic components

Indirect conversion type

Active matrix composed of:

I. Photodiode (a light sensor)

 Amplifies signal from incident light photons 2. Charge storage capacitor

• Stores signal of latent images

3. Thin-film transistor (or TFT switch)

 Latent images are read out and transferred to TFT switches that produce a voltage signal that is digitised and converted into the image

2. Image formation steps by direct conversion type

X-ray photon absorbed by a-Se photoconductor

Electrical charge carriers (negative electrons and positive holes are created in the a-Se (Selenium)

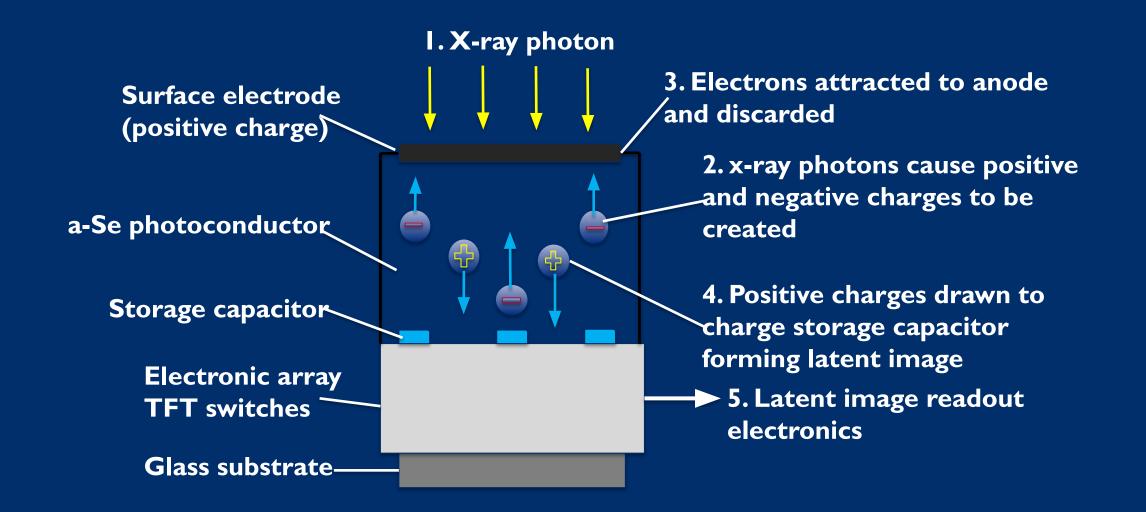
A surface electrode at positive potential attracts all the electrons

2. Image formation steps by direct conversion type – Cont.

The positive charges are drawn to the charge storage capacitor forming the latent image

The latent image is read out by TFT array

The resulting voltage signal is then digitised and transferred to the system computer where the DR image is built up



Direct conversion type

Post Processing

- I. Correction of artifacts:
 - Pixel-calibration uses values of neighbouring pixels to correct defects in pixel array
- 2. Auto-ranging:

- Analysis of histogram of image grey-scale data to reject very high and low value that contain no clinical information

Post Processing – Cont.

3. Digital image enhancement:

- Grey-scale modification - look-up-table (LUT) to remap grey- scale values and improve displayed images

 Spatial feature enhancement to produce enhanced composite images

Artifacts

Artifacts related to the image receptor

Artifacts related to software

Artifacts related to technical errors

I. Artifacts related to the image receptor

Light area on the image

Areas of dead pixels or a row of dead pixels

*dead pixels are unable to display the information deposited in their region of the image

"Ghosting" or "Image lag" (the appearance of anatomy image on the previous exposure)

Causes

- Any object on the surface of the image receptor (e.g., hair, dust, adhesive)
- Dust on the CR plate reader rollers

Mishandling of the image receptor
Caused by bending or cracks in the plate

Dead pixel correction software may provide some correction

• Inadequate erasure of an image receptor, or incorrect erasure settings

2. Artifacts related to software

Loss of information of the image (Artifacts related to software) Overprocessing the digital imageOver compression of the image

Reference: Christi E. Carter, Beth L. Vealé, Digital Radiography and PACS, 2nd Edition, 2014

Causes

3. Artifacts related to technical errors

Causes

Too light, too dark, or too noisy

(Artifacts related to technical errors)

Improper collimation
Misalignment of the exposure field

Quality Control of Digital Equipment

No	Equipment	Methods
1	All equipment	i. Initial acceptance testingii. Verify equipment matches specifications
2	CR plate maintenance	i. Inspect and clean IP regularlyii. Plate erasure at least every 48 hours
3	CR reader	Calibrate annually

Quality Control of Digital Equipment – Cont.

No	Equipment		Methods
4	DR plate maintenance	Ins	pect and clean regularly
5	Monitors	i.	Clean as needed
		ii.	Use QC monitor test pattern to verify
			image quality, resolution, presence of
			geometric distortion
	i	ii.	Measure luminance with a luminance
			meter
		iv.	Determine presence of reflections and
			their sources

THANKYOU!